September 2012



# FDP030N06B\_F102 N-Channel PowerTrench<sup>®</sup> MOSFET 60V, 195A, 3.1mΩ

### Features

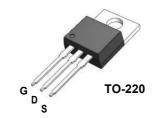
- $R_{DS(on)}$  = 2.67m $\Omega$  (Typ.) @  $V_{GS}$  = 10V, I<sub>D</sub> = 100A
- Low FOM R<sub>DS(on)</sub>\*Q<sub>G</sub>
- Low reverse recovery charge, Q<sub>rr</sub>
- Soft reverse recovery body diode
- · Enables highly efficiency in synchronous rectification
- Fast Switching Speed
- 100% UIL Tested
- RoHS Compliant

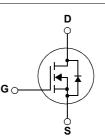
## Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

## Application

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- DC motor drives and Uninterruptible Power Supplies





#### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

Symbol		Parameter		FDP030N06B_F102	Units
V <sub>DSS</sub>	Drain to Source Voltage		60	V	
V <sub>GSS</sub>	Gate to Source Voltage	Voltage		±20	V
ID		- Continuous (T <sub>C</sub> = 25°C, Silic	ntinuous (T <sub>C</sub> = 25 <sup>o</sup> C, Silicon Limited)		A
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C, Sil	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C, Silicon Limited)		
		- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C, Pac	kage Limited)	120	1
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	780	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		600	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns	
P <sub>D</sub>	David Dia dia atian	(T <sub>C</sub> = 25°C)	$(T_{\rm C} = 25^{\rm o}{\rm C})$		W
	Power Dissipation	- Derate above 25°C		1.37	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300	°C	

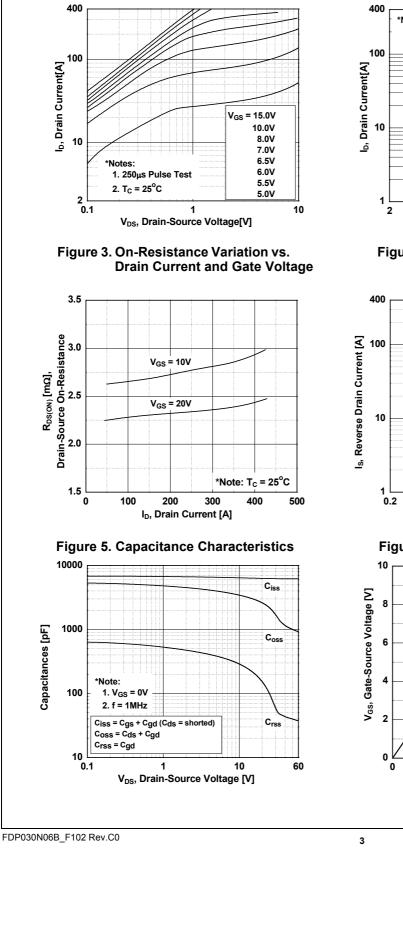
\* Package limitation current is 120A.

#### **Thermal Characteristics**

Symbol	Parameter	FDP030N06B_F102	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max	0.73	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max	62.5	°C/W

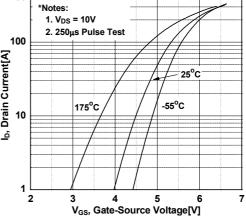
D300N06B_F102         istics         T <sub>C</sub> = 25°C unle         Parameter         Breakdown Voltage         age Temperature         age Temperature         age Drain Current         eakage Current         Voltage         Source On Resistance         ce         ance         er Capacitance         Output Capacitance         ge at 10V         Gate Charge         Ailler" Charge         Datage	$I_{D} = 250\mu$ $I_{D} = 250\mu$ $V_{DS} = 48$ $V_{GS} = \pm 2$ $V_{GS} = V_{D}$ $V_{GS} = 10$ $V_{DS} = 10$ $V_{DS} = 30$ $f = 1MHz$ $V_{DS} = 30$ $V_{DS} = 30$	noted Test Conditions LA, $V_{GS} = 0V$ LA, Referenced to 25 $V, V_{GS} = 0V$ $20V, V_{DS} = 0V$ $20V, V_{DS} = 0V$ $D_{DS}, I_D = 250\mu A$ $DV, I_D = 100A$ $DV, V_{GS} = 0V$ $DV, V_{GS} = 0V$ $DV, V_{GS} = 0V$ $DV, V_{GS} = 0V$ $DV, V_{GS} = 0V$		Min. 60 - - - - - - - - - - - - - -	Typ.           -           0.03           -           -           2.67           206           6035           1685           55           2619           76	50 Max. - - 1 ±100 4 3.1 - 8030 2240 - - 99	Units V V/°C μA nA N N S S PF pF pF pF nC
Parameter Parameter Breakdown Voltage age Temperature ge Drain Current eakage Current Voltage Source On Resistance conductance S ce ance er Capacitance Output Capacitance ge at 10V Gate Charge Ailler" Charge	$I_{D} = 250\mu$ $I_{D} = 250\mu$ $V_{DS} = 48$ $V_{GS} = \pm 2$ $V_{GS} = V_{D}$ $V_{GS} = 10$ $V_{DS} = 10$ $V_{DS} = 30$ $f = 1MHz$ $V_{DS} = 30$ $V_{DS} = 30$	Test Conditions         LA, $V_{GS} = 0V$ LA, Referenced to 25         LV, $V_{GS} = 0V$ 20V, $V_{DS} = 0V$ 20V, $V_{DS} = 0V$ 20V, $I_D = 100A$ 20V, $V_{GS} = 0V$		60 - - 2 - - - - - - - - - - -	- 0.03 - - 2.67 206 6035 1685 55 2619	- - 1 ±100 4 3.1 - 8030 2240 - -	V           V/°C           μA           nA           V           mΩ           S           pF           pF           pF           pF           pF           pF           pF
Parameter Parameter Breakdown Voltage age Temperature ge Drain Current eakage Current Voltage Source On Resistance conductance S ce ance er Capacitance Output Capacitance ge at 10V Gate Charge Ailler" Charge	$I_{D} = 250\mu$ $I_{D} = 250\mu$ $V_{DS} = 48$ $V_{GS} = \pm 2$ $V_{GS} = V_{D}$ $V_{GS} = 10$ $V_{DS} = 10$ $V_{DS} = 30$ $f = 1MHz$ $V_{DS} = 30$ $V_{DS} = 30$	Test Conditions         LA, $V_{GS} = 0V$ LA, Referenced to 25         LV, $V_{GS} = 0V$ 20V, $V_{DS} = 0V$ 20V, $V_{DS} = 0V$ 20V, $I_D = 100A$ 20V, $V_{GS} = 0V$		60 - - 2 - - - - - - - - - - -	- 0.03 - - 2.67 206 6035 1685 55 2619	- - 1 ±100 4 3.1 - 8030 2240 - -	V           V/°C           μA           nA           V           mΩ           S           pF           pF           pF           pF           pF           pF           pF
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Voltage Source On Resistance conductance <b>S</b> ce ance er Capacitance Output Capacitance ge at 10V Gate Charge Ailler" Charge	$V_{DS} = 48$ $V_{GS} = \pm 2$ $V_{GS} = V_{I}$ $V_{GS} = 10$ $V_{DS} = 10$ $V_{DS} = 10$ $V_{DS} = 30$ $f = 1MHz$ $V_{DS} = 30$ $V_{DS} = 30$	$BV, V_{GS} = 0V$ $20V, V_{DS} = 0V$ $DS, I_D = 250 \mu A$ $DV, I_D = 100A$ $DV, I_D = 100A$ $DV, V_{GS} = 0V$ $DV, V_{GS} = 0V$ $DV, V_{GS} = 0V$ $DV, I_D = 100A$		- - - - - - - - - - - -	- - 2.67 206 6035 1685 55 2619	1 ±100 4 3.1 - 8030 2240 - -	μΑ nA V mΩ S PF pF pF
Voltage Source On Resistance conductance <b>S</b> ce ance er Capacitance Output Capacitance ge at 10V Gate Charge Ailler" Charge	$V_{GS} = \pm 2$ $V_{GS} = V_{I}$ $V_{GS} = 10$ $V_{DS} = 10$ $V_{DS} = 30$ $f = 1MHz$ $V_{DS} = 30$ $V_{DS} = 30$	$P_{DOV}, V_{DS} = 0V$ $P_{DS}, I_D = 250 \mu A$ $P_{DV}, I_D = 100A$ $P_{DV}, V_{GS} = 100A$ $P_{DV}, V_{GS} = 0V$ $P_{DV}, V_{GS} = 0V$ $P_{DV}, V_{GS} = 0V$ $P_{DV}, I_D = 100A$		- 2 - - - - - - - -	- 2.67 206 6035 1685 55 2619	±100 4 3.1 - 8030 2240 - -	nA V mΩ S PF pF pF
Voltage Source On Resistance conductance <b>S</b> ce ance er Capacitance Output Capacitance ge at 10V Gate Charge Ailler" Charge	$V_{GS} = V_{I}$ $V_{GS} = 10$ $V_{DS} = 10$ $V_{DS} = 30$ $f = 1MHz$ $V_{DS} = 30$ $V_{DS} = 30$	$_{DS}$ , $I_D = 250 \mu A$ $_{DV}$ , $I_D = 100A$ $_{DV}$ , $I_D = 100A$ $_{DV}$ , $V_{GS} = 0V$ $_{Z}$ $_{DV}$ , $V_{GS} = 0V$ $_{DV}$ , $V_{GS} = 0V$ $_{DV}$ , $V_{GS} = 0V$		2 - - - - - - - -	- 2.67 206 6035 1685 55 2619	4 3.1 - 8030 2240 - -	V mΩ S pF pF pF
Source On Resistance conductance <b>S</b> ce ance er Capacitance Output Capacitance ge at 10V Gate Charge Ailler" Charge	$V_{GS} = 10$ $V_{DS} = 10$ $V_{DS} = 30$ $f = 1MHz$ $V_{DS} = 30$ $V_{DS} = 30$ $V_{DS} = 30$	$V, I_D = 100A$ $V, I_D = 100A$ $V, V_{ID} = 100A$ $V, V_{GS} = 0V$ $V, V_{GS} = 0V$ $V, V_{GS} = 0V$ $V, I_D = 100A$		- - - - - - - - -	2.67 206 6035 1685 55 2619	3.1 - 8030 2240 - -	mΩ S pF pF pF
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ge at 10V Gate Charge ⁄Iiller" Charge	V <sub>DS</sub> = 30	)V, I <sub>D</sub> = 100A		-			
Gate Charge /iller" Charge			_	-	70	99	
Ailler" Charge				-	29	-	nC
		V <sub>GS</sub> = 10V (Note 4)		_	12	-	nC
				-	5.2		V
Jaige	$V_{\rm DO} = 30$	0V, V <sub>GS</sub> = 0V	(Note 4)	_	92.4		nC
	105 00	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,			02.1	<u> </u>	
CS							
Time				-	32	74	ns
me		$V_{DD}$ = 30V, $I_D$ = 100A $V_{GS}$ = 10V, $R_{GEN}$ = 4.7 $\Omega$		-	33	76	ns
Time	$v_{GS} = 10$			-	56	122	ns
ne			(Note 4)	-	23	56	ns
es Resistance (G-S)	Drain Op	en, f = 1MHz		-	2.0	-	Ω
aracteristics							
	ode Forward	Current		-	-	195*	Α
d Drain to Source Diode	Forward Curr	rent		-	-	780	Α
Diode Forward Voltage	V <sub>GS</sub> = 0V	/, I <sub>SD</sub> = 100A		-	-	1.25	V
ery Time	$V_{GS} = 0$	/, I <sub>SD</sub> = 100A		-	71	-	ns
ery Charge				-	78	-	nC
	Fime me Fime Fime Pas Resistance (G-S) Aracteristics Inuous Drain to Source Diode Diode Forward Voltage Pry Time Pary Charge In maximum junction temperature SS, Starting T <sub>J</sub> = 25°C	Fime $V_{DD} = 30$ me $V_{GS} = 10$ ne $P_{GS} = 10$ es Resistance (G-S)       Drain Op         aracteristics       Drain to Source Diode Forward Curr         nuous Drain to Source Diode Forward Curr       Diode Forward Voltage         Diode Forward Voltage $V_{GS} = 0$ ery Time $V_{GS} = 0$ ery Charge $dI_F/dt = 7$	Fime $V_{DD} = 30V, I_D = 100A$ me $V_{GS} = 10V, R_{GEN} = 4.7\Omega$ ne $P_{GS} = 10V, R_{GEN} = 4.7\Omega$ he $P_{GS} = 0V, I_{SD} = 100H$ he $P_{GS} = 0V, I_{SD} = 100A$ he $V_{GS} = 0V, I_{SD} = 100A$ hery Time $V_{GS} = 0V, I_{SD} = 100A$ hery Charge $H_F/dt = 100A/\mu s$ Her maximum junction temperature $P_{SS}, Starting T_J = 25^{\circ}C$	Fime $V_{DD} = 30V, I_D = 100A$ me $V_{GS} = 10V, R_{GEN} = 4.7\Omega$ ne       (Note 4)         as Resistance (G-S)       Drain Open, f = 1MHz         aracteristics         nuous Drain to Source Diode Forward Current         d Drain to Source Diode Forward Current         Diode Forward Voltage $V_{GS} = 0V, I_{SD} = 100A$ ery Time $V_{GS} = 0V, I_{SD} = 100A$ ery Charge $dI_F/dt = 100A/\mu s$	Filme       -         me $V_{DD}$ = 30V, $I_D$ = 100A         Filme $V_{GS}$ = 10V, $R_{GEN}$ = 4.7Ω         ne       (Note 4)         es Resistance (G-S)       Drain Open, f = 1MHz         practeristics         nuous Drain to Source Diode Forward Current         d Drain to Source Diode Forward Current         Diode Forward Voltage         V <sub>GS</sub> = 0V, I <sub>SD</sub> = 100A         erry Time         V <sub>GS</sub> = 0V, I <sub>SD</sub> = 100A         erry Time         V <sub>GS</sub> = 0V, I <sub>SD</sub> = 100A         erry Charge         dI <sub>F</sub> /dt = 100A/µs	$\begin{tabular}{ c c c c c c } \hline Filme & V_{DD} = 30V, I_D = 100A & & & & & & & & & & & & & & & & & & $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

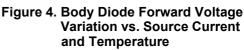




**Typical Performance Characteristics** 

#### Figure 1. On-Region Characteristics Figure 2. Transfer Characteristics Figure 2. Transfer Characteristics Votes: 1. V<sub>DS</sub> = 10V 2. 250µS Pulse Test





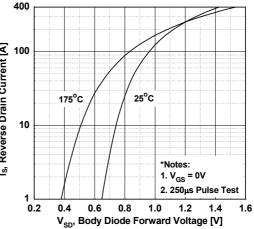
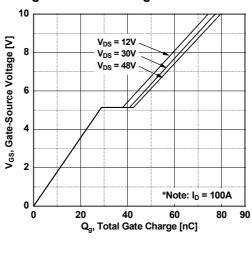
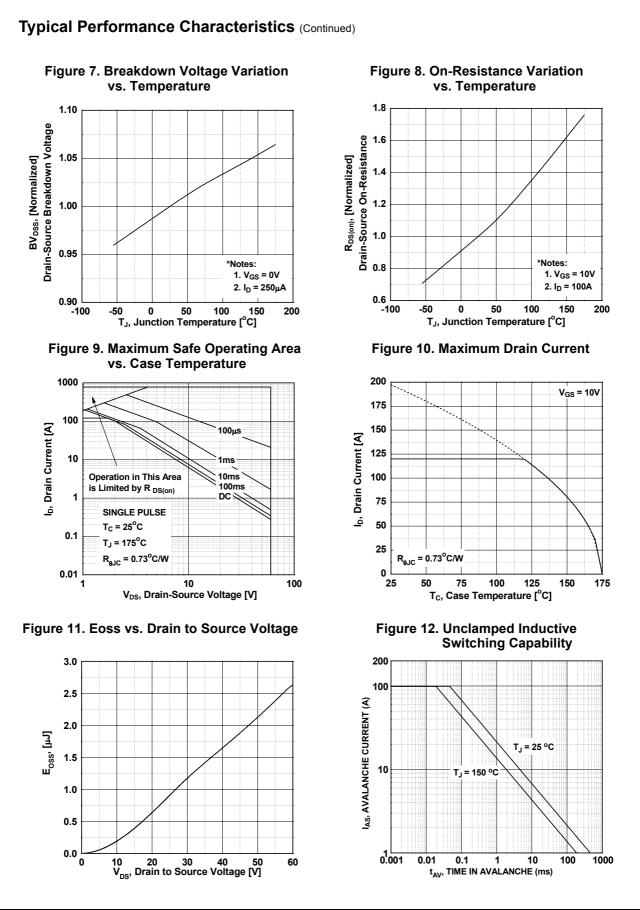
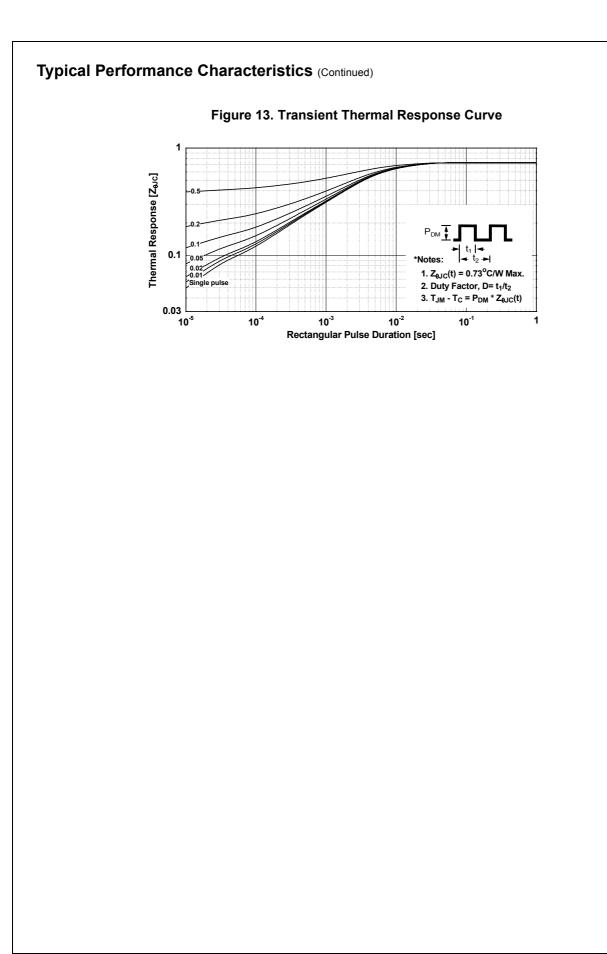
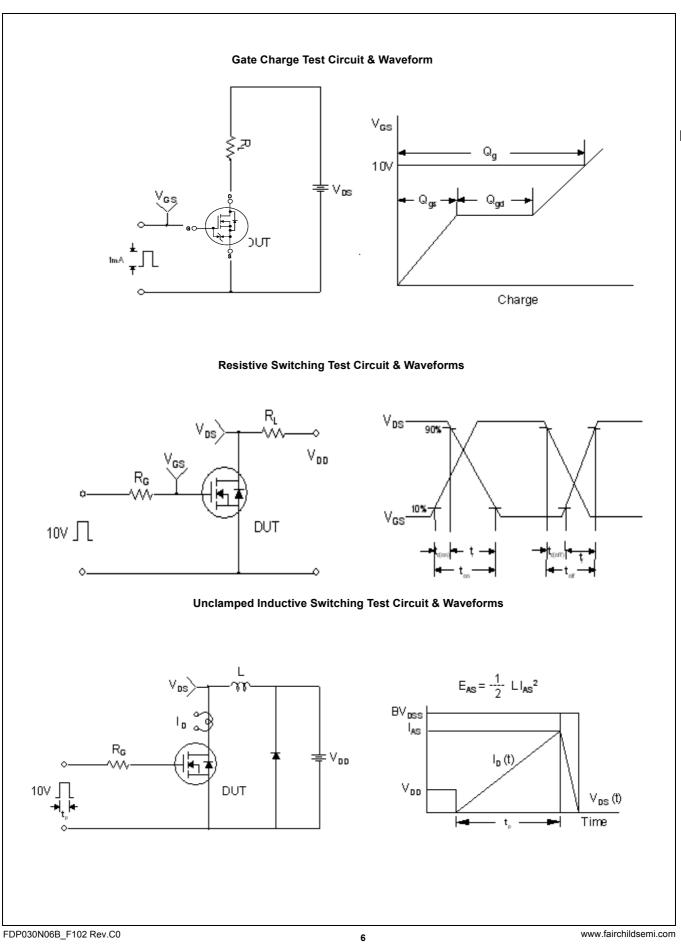


Figure 6. Gate Charge Characteristics

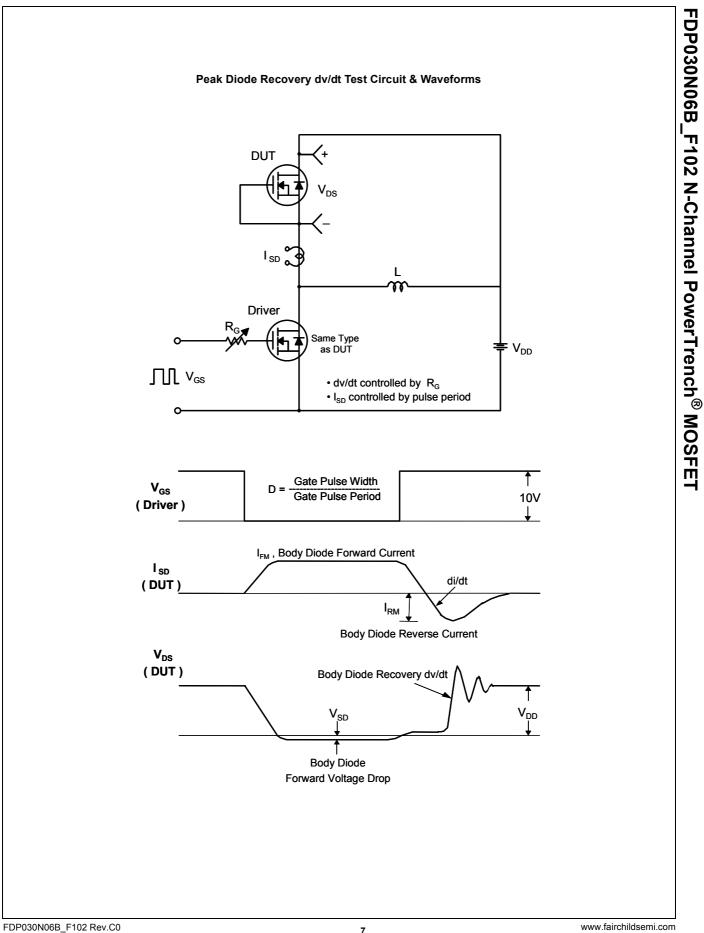


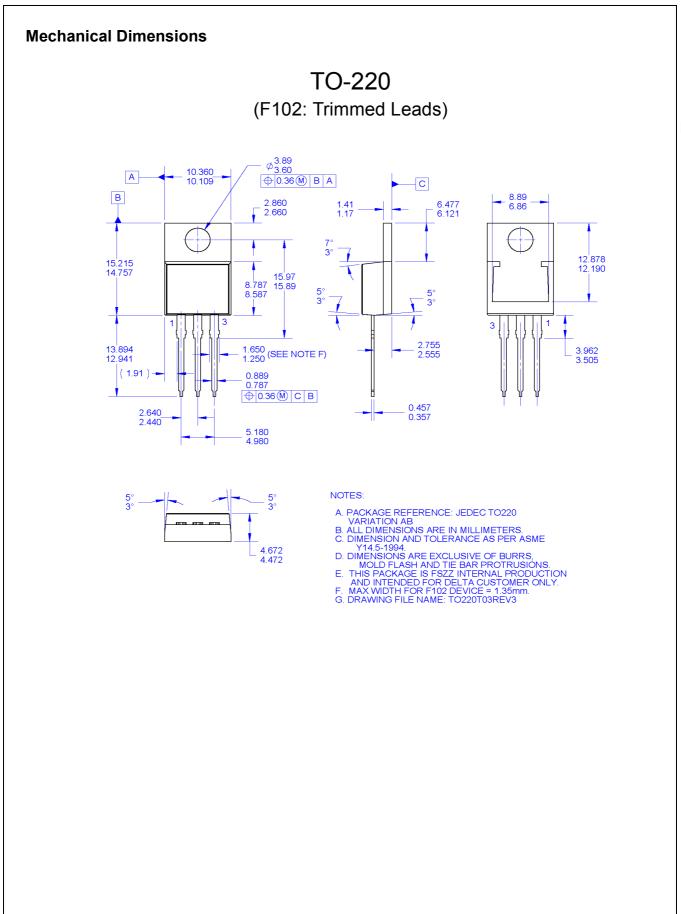






FDP030N06B\_F102 N-Channel PowerTrench<sup>®</sup> MOSFET







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DEUXPEED®
Dual Cool™_
EcoSPARK <sup>®</sup>
EfficentMax™
ESBC™
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- 2 A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 161

<sup>:</sup>DP030N06B\_F102 N-Channel PowerTrench<sup>®</sup> MOSFE<sup>:</sup>